

Specification MSBT801

SSC		CUSTOMER
Drawn	Approval	Approval

Rev. 00

November 2007



MSBT801

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MSBT801

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Description

This surface-mount LED comes in PLCC standard package dimension. It has a substrate made up of a molded plastic reflector sitting on top of a bent lead frame. The die is attached within the reflector cavity and the cavity is encapsulated by epoxy or silicone

The package design coupled with careful selection of component materials allow these products to perform with high reliability in a larger temperature range -40 °C to 100 °C. The high reliability feature is crucial to Automotive interior and Indoor ESS.



Features

- Industry Standard PLCC
 SMT package
- High brightness using AllnGaP and InGaN dice technologies
- Available in multiple colors
- High volume, high reliability

Applications

- Interior automotive
- Electronic Signs and Signals
- Office Automation,
 Electrical Appliances,
 Industrial Equipment

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1. Features

- SKY BLUE colored SMT package
- Material INGaN/SiC
- Suitable for all SMT assembly methods
 Suitable for all soldering methods
- RoHS Compliant

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2. Absolute maximum ratings

Parameter	Symbol	Value	Unit
Power Dissipation	P_d	120	mW
Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} *2	90	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T _{opr}	-40 ~ +100	°C
Storage Temperature	$T_{ m stg}$	-40 ~ +100	°C

^{*1} Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

3. Electric characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	V_F	I _F =20mA	2.7	3.3	4.0	V
Reverse Current	I _R	V _R =5V	-	-	10	μА
Luminance Intensity *1	I_V	I _F =20mA	150	300	450	mcd
Peak Wavelength	λ_P	I _F =20mA	-	455	-	nm
Color Coordinate (x,y)	X	/ -20m/	0.135	0.150	0.167	
	У	<i>I_F</i> =20mA	0.059	0.070	0.081	_
Spectral Bandwidth 50%	Δλ	I _F =20mA	-	23	-	nm
Viewing Angle *2	201/2	I _F =20mA	-	120	-	deg.

^{*1.} The luminous intensity IV was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package. Luminous Intensity Measurement allowance is $\pm 10\%$

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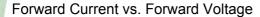
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^{*2} *IFM* was measured at $\overrightarrow{TW} \le 1$ msec of pulse width and D $\le 1/10$ of duty ratio.

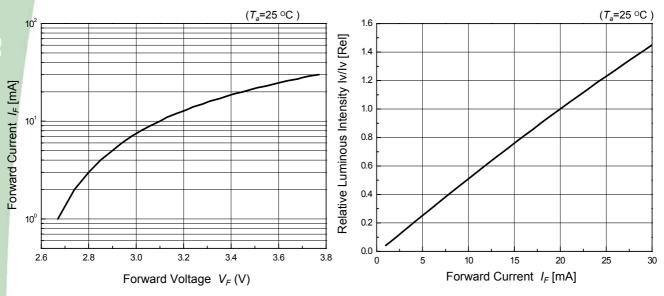
^{*2.} 2θ ½ is the off-axis where the luminous intensity is 1/2 of the peak intensity.

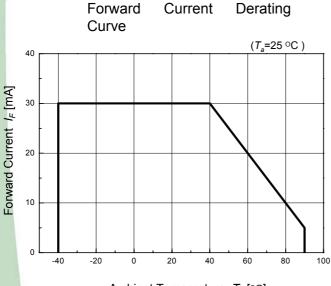


4. Optical characteristics

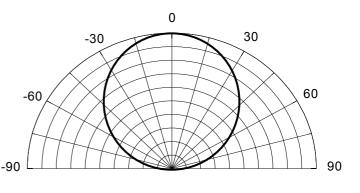


Relative Luminous Intensity vs Forward Current





Radiation Diagram

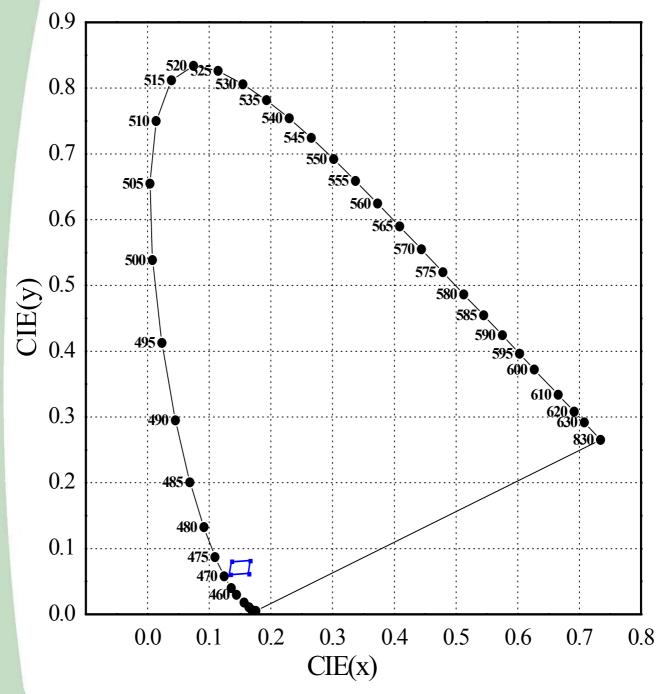


Ambient Temperature T_A [°C]

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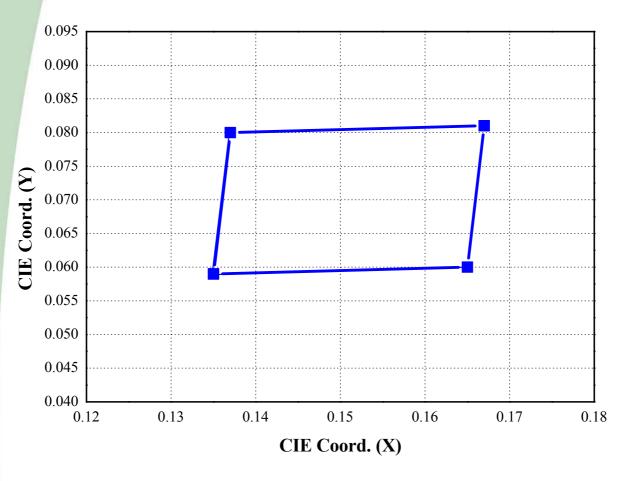


5. CIE Chromaticity Diagram



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● COLOR RANK <IF=20mA, Ta=25°C>

Color Coordinate		
Х	У	
0.135	0.059	
0.165	0.060	
0.137	0.080	
0.167	0.081	

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^{*} Measurement Uncertainty of the Color Coordinates : $\pm~0.01$

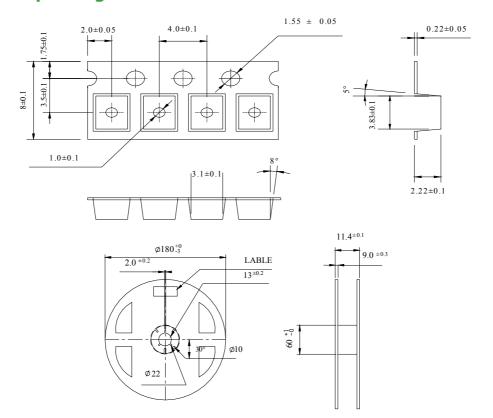


Recommended Solder Pattern

6.outline dimension

2.8 2.2 O.15 Anode Cathode Mark (Tolerance: ±0.2, Unit: mm)

7. packing

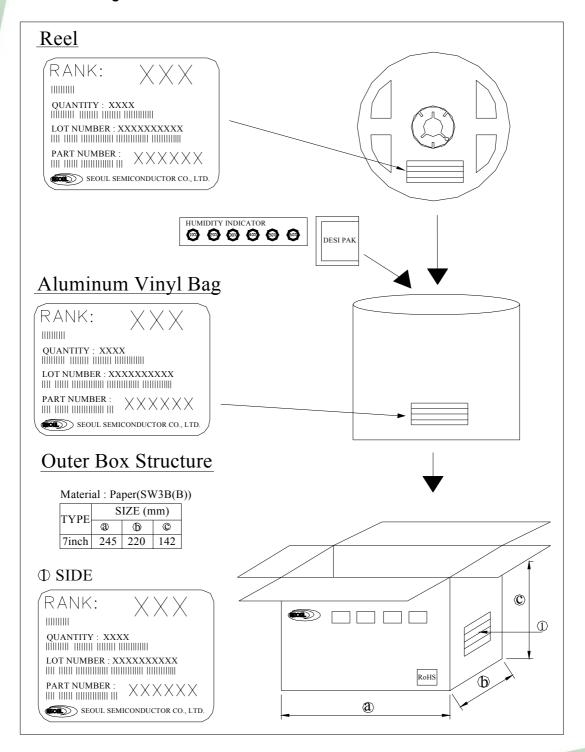


- (1) Quantity: 2000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ± 0.2 mm
- (3) Adhesion Strength of Cover Tape: Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package

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Reel Packing Structure



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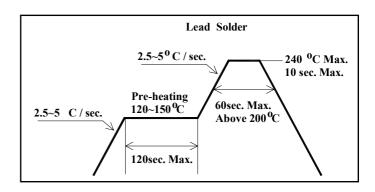
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8. soldering

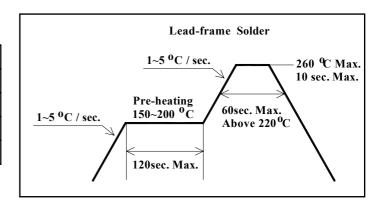
(1) Lead Solder

Lead Solder		
Pre-heat	120~150℃	
Pre-heat time	120 sec. Max.	
Peak-Temperature	240℃ Max.	
Soldering time Condition	10 sec. Max.	



(2) Lead-Free Solder

Lead Free Solder		
Pre-heat	150~200℃	
Pre-heat time	120 sec. Max.	
Peak-Temperature	260℃ Max.	
Soldering time Condition	10 sec. Max.	



(3) Hand Soldering conditions
Do not exceed 4 seconds at maximum 315°C under soldering iron.

Note: In case that the soldered products are reused in soldering process, we don't guarantee the products.

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9. precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in a dry box (or a desicator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature: 5°C ~30°C Humidity: maximum 70%RH

(2) Attention after open.

LED is correspond to SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed; Keeping of a fraction

Temperature: 5 ~ 40°C Humidity: less than 10%

- (3) In the case of more than 1 week passed after opening or change color of indicator on desiccant, components shall be dried 10-12hr. at $60\pm5^{\circ}$ C.
- (4) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- (5) Quick cooling shall be avoided.
- (6) Components shall not be mounted on warped direction of PCB.
- (7) Anti radioactive ray design is not considered for the products.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent etc. When washing is required, IPA should be used.
- (9) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (10) The LEDs must be soldered within seven days after opening the moisture-proof packing.
- (11) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (12) The appearance and specifications of the product may be modified for improvement without notice.

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APB3025SGNC APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB-CN1R1H1BB7D3D3 LTST-C250KGKT
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